TECHNICAL DATA SHEETS	ENVELOPE GASKETS
	CATEGORY: FLANGE SEAL MANUFACTURER: IDT PROFILE: ED10 DIMENSION: EN 1514-3 [EN12560-3] MATERIAL: WS 7110 / 3825
 Very good media resist. [except liquid alkali mtls.] Long-term stable compression - recovery charact. Excellent [di]electric properties, Anti-adhesive surf. 	 For aggressive media which is hazardous for health Use in food sector and pharmaceutical production Used for high requirements in process purity
PRODUCT NAME	FEATURES
Envelope gasket with diffusion barrier and SIGRAFLEX® EMAIL graphite insert	The PTFE-envelope of the sealing system consists of Dyneon [™] TFM [™] 1600 and has an interior diffusion barrier [3.0mm]. The SIGRAFLEX® EMAIL insert is 3.0mm. Leading enamel flange manufacturers recommend this gasket up to nominal width DN 200,
PROFILE	exceeding that width the profile ED30 with a thickness of 6.5mm.
ED10	Complies with TA Luft and VDI 2290 ¹ . Conductive design possible.
OPERATIONAL DATA	
Pressure	Max. 20 bar ²
Temperature Density [mDIN 2505]	-200°C to 200°C [short term 230°C]
σ _{VU0.1} σ _{VO} σ _{BO300°C [200°C]}	
APPROVALS TA Luft 2002 [VDI 2440/2200]	X
BAM oxygen	
BAM ethylene/propylene	
DVGW [DIN 3535-6]	
KTW-guideline	
Fire Safe Test	X*
FDA	
EG 1935/2004 Blow-out resistance	
Germanischer Lloyd	
Notes: 'complies with VDI 2290 only in combination with a leakage	ne certificate as ner EN 1591-1

² max. pressure and max. temperature should not occur at the same time * for additional information refer to approvals